

3A, 600V Standard Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

- · Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
lF	3	Α	
V_{RRM}	600	V	
I _{FSM}	50	А	
T _{J MAX}	150	°C	
Package	Thin SMA		
Configuration	Single die		









Thin SMA



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	S3JAL	UNIT
Marking code on the device			S3JAL	
Repetitive peak reverse voltage		V _{RRM}	600	V
Reverse voltage, total rms value		V _{R(RMS)}	420	V
Forward current		lf	3	А
Surge peak forward current single	t = 8.3ms	_	50	Α
half sine wave superimposed on rated load	t = 1.0ms	I _{FSM}	140	А
Junction temperature		TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C





THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R _{OJL}	14	°C/W
Junction-to-ambient thermal resistance	Reja	74	°C/W
Junction-to-case thermal resistance	Rejc	20	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 1.5A, T _J = 25°C	VF	0.95	-	V
	I _F = 3.0A, T _J = 25°C		1.03	1.10	V
	I _F = 1.5A, T _J = 125°C		0.84	-	V
	I _F = 3.0A, T _J = 125°C		0.94	-	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C		-	1	μΑ
	T _J = 125°C	· I _R	7	-	μΑ
Junction capacitance	1MHz, V _R = 4.0V	Сл	14	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
S3JAL	Thin SMA	14,000 / Tape & Reel	



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

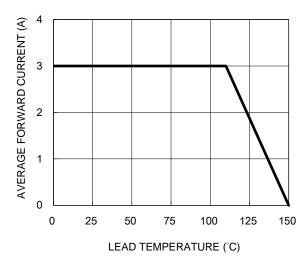


Fig.3 Typical Reverse Characteristics

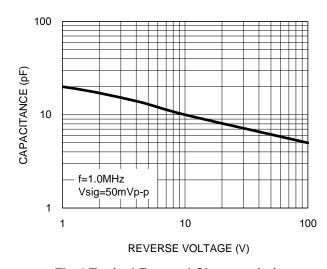
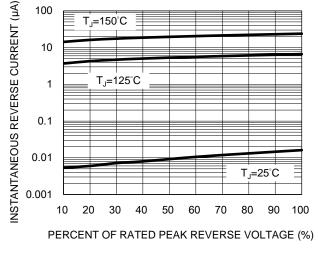


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



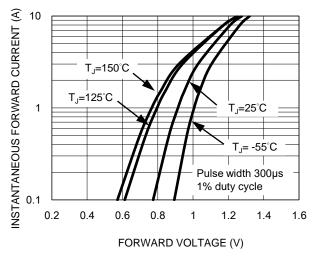
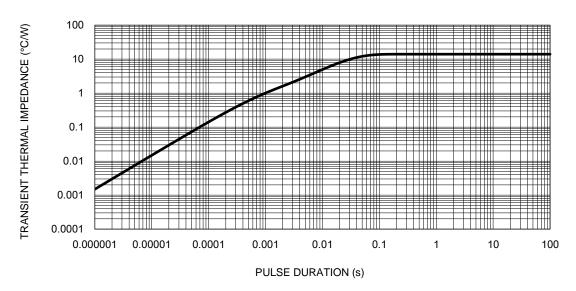


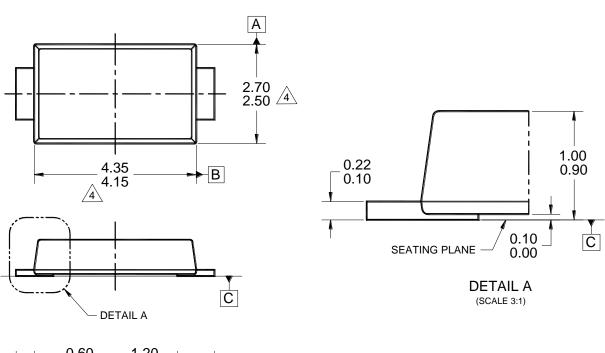
Fig.5 Typical Transient Thermal Impedance

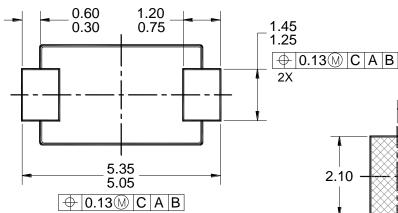


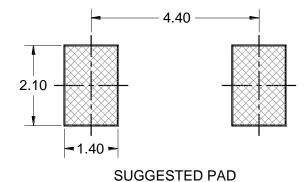


PACKAGE OUTLINE DIMENSIONS

Thin SMA







P/N SYWF

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.

LAYOUT

- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-221, VARIATION AC, ISSUE B.
- MODED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- 5. SUGGESTED PAD LAYOUT IS FOR REFERENCE PURPOSE ONLY.
- 6. DWG NO. REF: HQ2SD07-TSMA-074 REV A.

MARKING DIAGRAM

P/N = MARKING CODE YW = DATE CODE

F = FACTORY CODE



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